TOSHIBA THYRISTOR SILICON PLANAR TYPE

URSF05G49-1P,URSF05G49-3P,URSF05G49-5P

LOW POWER SWITCHING AND CONTROL APPLICATIONS

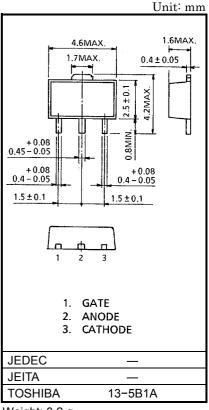
 Repetitive Peak Off-State Voltage: VDRM = 400V Repetitive Peak Reverse Voltage: VRRM = 400V
 Average On-State Current: IT (AV) = 500mA

• Reduce a Quantity of Parts and Manufacturing

Process Because of Built-in RGK : $RGK = 1k\Omega$, $2.7k\Omega$, $5.1k\Omega$ (Typ.)

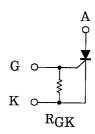
MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATINGS	UNIT	
Repetitive Peak Off-State Voltage and Repetitive Peak Reverse Voltage	$V_{ m DRM} \ V_{ m RRM}$	400	V	
Non-Repetitive Peak Reverse Voltage (Non-Repetitive<5ms, $T_j = 0 \sim 125$ °C)	V_{RSM}	500	V	
Average On-State Current (Half Sine Waveform)	I _{T (AV)}	500	mA	
R.M.S On-State Current	I _{T (RMS)}	800	mA	
Peak One Cycle Surge On-State	I _{TSM}	9 (50Hz)	Α	
Current (Non-Repetitive)		10 (60Hz)		
I ² t Limit Value	I ² t	0.4	A ² s	
Critical Rate of Rise of On-State Current (Note 1)	di / dt	10	A/µs	
Peak Gate Power Dissipation	P_{GM}	0.1	W	
Average Gate Power Dissipation	P _{G(AV)}	0.01	W	
Peak Forward Gate Voltage	V_{FGM}	3.5	V	
Peak Reverse Gate Voltage	V_{RGM}	-5	٧	
Peak Forward Gate Current	I _{GM}	125	mA	
Junction Temperature	Tj	-40~125	°C	
Storage Temperature Range	T _{stg}	-40~125	°C	



Weight: 0.2 g

EQUIVALENT CIRCUIT



NOTE 1: di / dt Test condition $i_G = 5mA, t_{gw} = 10\mu s,$ $t_{gr} \le 250ns$



ELECTRICAL CHARACTERISTICS (Ta = 25°C)

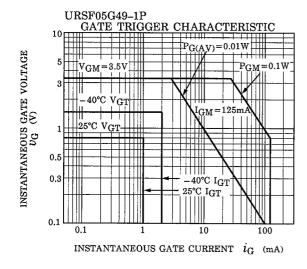
CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Repetitive Peak Off-State Current and Repetitive Peak Reverse Current		I _{DRM} I _{RRM}	V _{DRM} = V _{RRM} = Rated	_	_	10	μΑ
Peak On-State Voltage		V _{TM}	I _{TM} = 1A	_	_	1.5	V
Gate Trigger Voltage		V _{GT}		_	_	0.8	V
Gate Trigger Current	URSF05G49-1P	l _{GT}	$V_D = 6V, R_L = 100\Omega$	250	700	1000	μA
	URSF05G49-3P			100	250	400	
	URSF05G49-5P			50	160	250	
Holding Current	URSF05G49-1P	lн	I _{TM} = 500mA, V _D = 6V	_	_	6	mA
	URSF05G49-3P			_	_	3	
	URSF05G49-5P			_	_	2	
Resistor Between Gate and Cathode	URSF05G49-1P	R _{GK}	_	700	1000	1300	Ω
	URSF05G49-3P			1890	2700	3510	
	URSF05G49-5P			3570	5100	6630	
Critical Rate of Rise of Off-State Voltage	URSF05G49-1P	d _V / dt	V _{DRM} = Rated, Exponential Rise	_	200	_	V / µs
	URSF05G49-3P			_	70	_	
	URSF05G49-5P			_	40	_	
Turn-On Time		t _{gt}	V _D = Rated, i _G = 5mA	_	_	1.5	μs
Thermal Resistance		R _{th (j−a)}	Junction to Ambient	_	_	70	°C/W

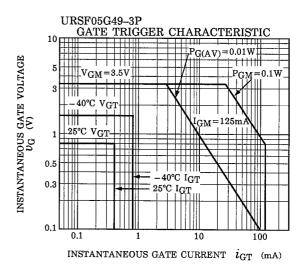
Note: Thermal Resistance Test Condition Use 0.6×30×30mm Alumina Plate

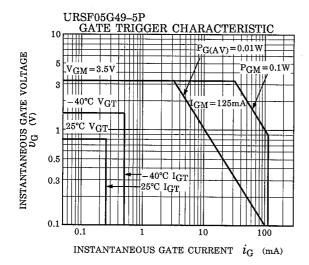
MARK

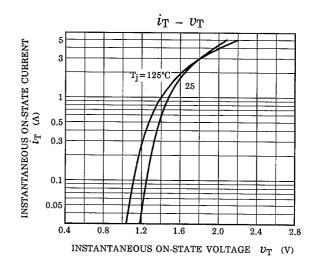


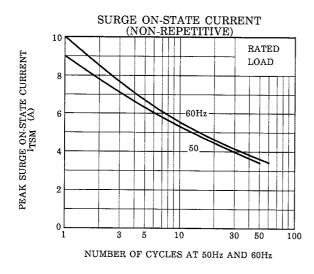
NUMBER	TYPE	MARK		
	URSF05G49-1P	PB		
* 1	URSF05G49-3P	PC		
	URSF05G49-5P	PD		

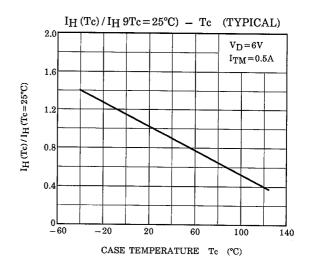


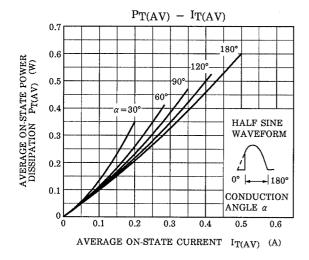


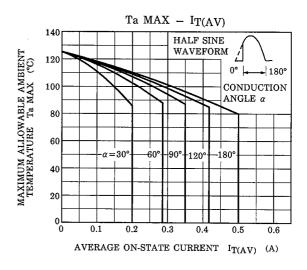


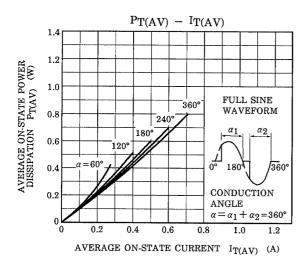


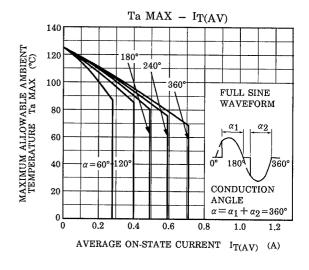


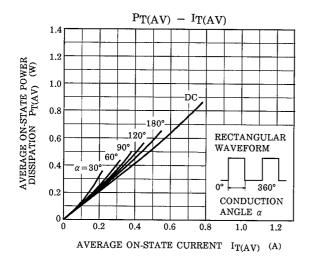


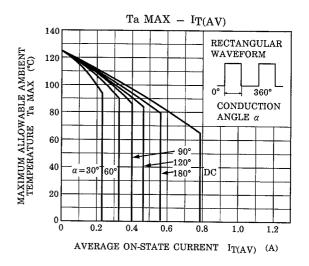


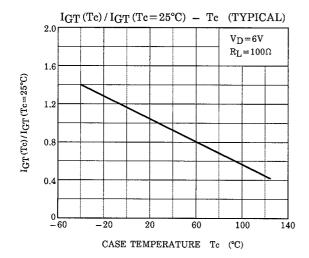


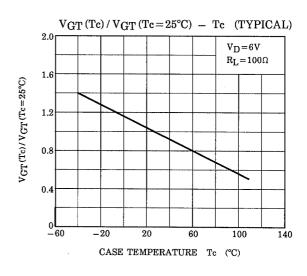


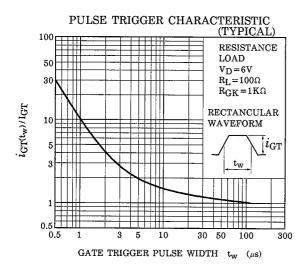


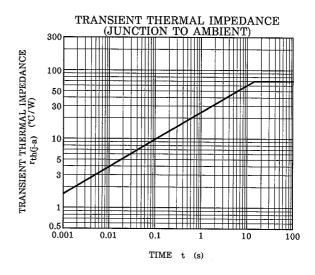












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